

VOLTAGE RANGE: 20 - 40V

CURRENT: 1.0 A

Features

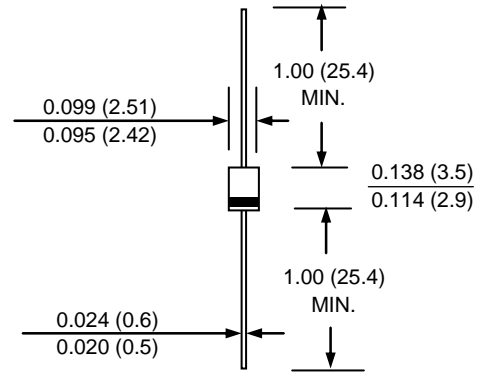
- Metal-Semiconductor junction with guard ring
- Epitaxial construction
- Low forward voltage drop, low switching losses
- High surge capability
- For use in low voltage, high frequency inverters free wheeling, and polarity protection applications
- The plastic material carries U/L recognition 94V-0

Mechanical Data

- Case: JEDEC R-1 molded plastic
- Terminals: Axial lead, solderable per MIL-STD-202 Method 208
- Polarity: Color band denotes cathode
- Weight: 0.007 ounces, 0.20 grams



R-1



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	1N17	1N18	1N19	Unit
Maximum recurrent peak reverse voltage	V _{RRM}	20	30	40	V
Maximum RMS voltage	V _{RMS}	14	21	28	V
Maximum DC blocking voltage	V _{DC}	20	30	40	V
Maximum average forward rectified current 9.5mm lead length, @T _A =75°C	I _{F(AV)}	1.0			A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @T _J =70°C	I _{FSM}	25.0			A
Maximum instantaneous forward voltage @ 1.0A (Note 1) @ 3.0A	V _F	0.45 0.75	0.55 0.875	0.60 0.90	V
Maximum reverse current @T _A =25°C at rated DC blocking voltage @T _A =100°C	I _R	1.0 10.0			mA
Typical junction capacitance (Note2)	C _J	110			pF
Typical thermal resistance (Note3)	R _{θJA}	50			°C/W
Operating junction temperature range	T _J	- 55 ---- + 125			°C
Storage temperature range	T _{STG}	- 55 ---- + 150			°C

NOTE: 1. Pulse test : 300 μs pulse width, 1% duty cycle.

2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance junction to ambient



FIG.1 – FORWARD DERATING CURVE

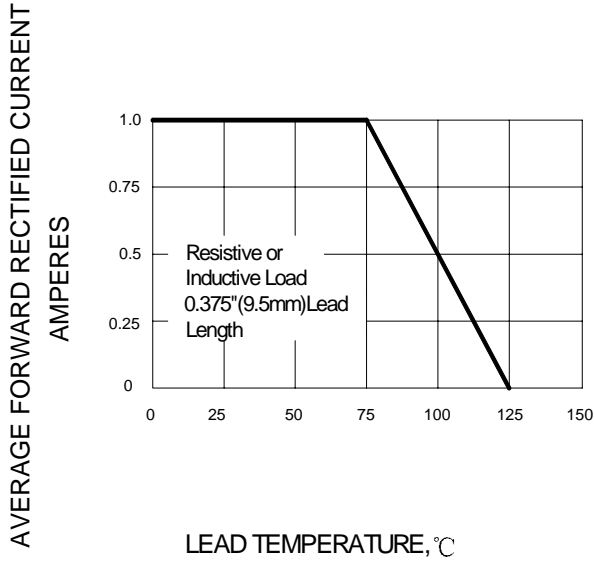


FIG.2 – PEAK FORWARD SURGE CURRENT

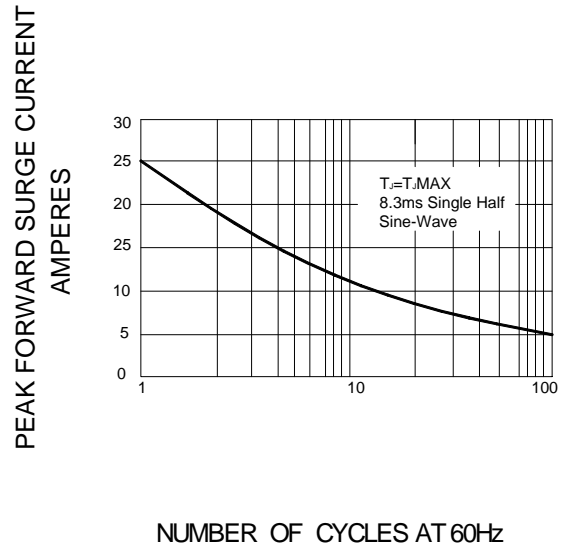


FIG.3 – TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

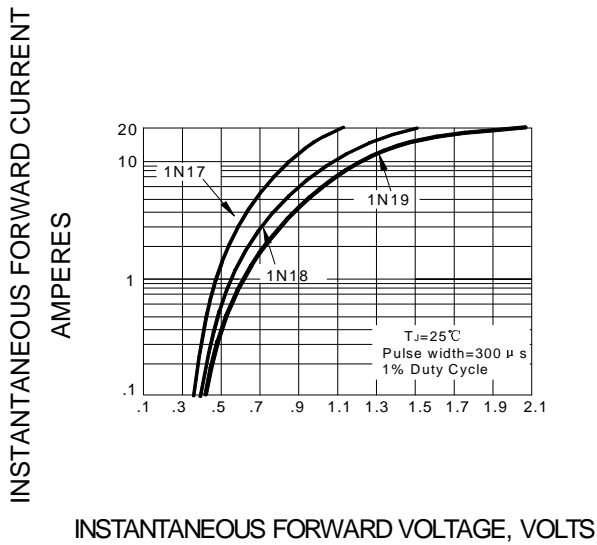


FIG.4 – TYPICAL JUNCTION CAPACITANCE

